ASSOCIATION CONNECTI ELECTRONICS INDUSTRI	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				under both T	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.							
1752-2 1.1	1.1 IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute			Form Type * Distribute		Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg Information							
Supplier Inform	nation												
Company name*			Company unique ID				Unique ID Authority			Response Date*			
On Semiconductor										2017-11	-13		
Contact Name			Title - Contact				Phone - Contact*			Email - Contact*			
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Reques	ter Item Number	Mfr Item Numbe		ber Mfr Item Name			Effective Date	Version	Manufacturing Site		Weight*	UOM	Unit Type
		NCP694DSANADJT1 1A CMOS B/S LI G		DO		2017-11-13 I		RICOH, RICOH F/G		18.0	mg	Each	
Manufacturing	Process Information	1											
Termina	Terminal Plating / Grid Array Material		Terminal Base Alloy J-STD-020 MS		J-STD-020 MSL I	Rating	Peak Process Body Temperature Max Time at I			ak Temperature Number of Reflow Cycles			
					1		260	C	30	secon	ds 3		

RoHS Material Composition Declaration		Declaration Type *	Detailed							
	RoHS Definition: Quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury, Hexavalent Chromium, Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mass (100 PPM) of homogeneous material for Cadmium									
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier have provided as part of that agreement, will be the sole and exclusivesource of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale appl										
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substances per	r the definition above	Supplier Acceptance	* Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.										
Exemption List Version	EL-2006/690/EC									
Declaration Signature										
Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.										
Supplier Digital Signature	Rastislav Drska									

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.91	mg	Supplier	Silicon (Si)	7440-21-3		0.91	mg
Die Attach	0.064	mg	Supplier	Silver (Ag)	7440-22-4		0.048	mg
			Supplier	Epoxy resins	129915-35-1		0.016	mg
Lead Frame	6.757		Supplier	Silver (Ag)	7440-22-4		0.275	mg
			Supplier	Tin (Sn)	7440-31-5		0.0169	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0149	mg
			Supplier	Chromium (Cr)	7440-47-3		0.0169	mg
			Supplier	Silicon (Si)	7440-21-3		0.002	mg
			Supplier	Copper (Cu)	7440-50-8		6.4313	mg
Mold Compound-Black	10.165		Supplier	Organic Phosphorus compound	n/a		0.0508	mg
			Supplier	Epoxy + Phenol Resin	n/a		1.2198	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0305	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		8.8639	mg
Plating	0.046	mg	Supplier	Tin (Sn)	7440-31-5		0.046	mg
Wire Bond - Au	0.058	mg	Supplier	Gold (Au)	7440-57-5		0.058	mg